

| L Number | Hits | Search Text | DB | Time stamp |
|-------------|------|--|---|---------------------|
| - | 368 | buried adj source | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2003/03/21 11:12 |
| - | 243 | buried adj interconnect\$3 | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2003/03/21 11:17 |
| - | 1573 | semiconductor and common adj source adj line | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2003/03/21 11:30 |
| - | 1 | | USPAT | 2003/03/21 11:45 |
| - | 1 | | USPAT | 2003/03/21 11:47 |
| - | 1 | | USPAT | 2003/03/21 11:47 |
| - | 10 | semiconductor and (source same connecting adj area) | USPAT | 2003/03/21 11:52 |
| - | 12 | semiconductor and (source same connecting adj area) | US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2003/03/21 11:53 |